

## NCE N-Channel Enhancement Mode Power MOSFET

#### Description

The NCE2010E uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

#### **General Features**

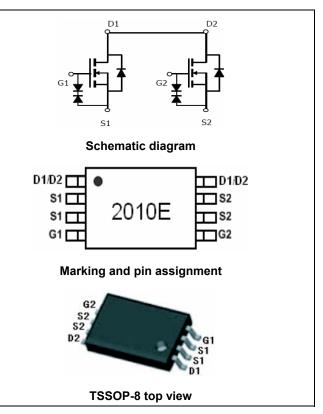
• V<sub>DS</sub> = 20V,I<sub>D</sub> =7A

$$\begin{split} & R_{DS(ON)} < 24m\Omega @ V_{GS} = 2.5V \\ & R_{DS(ON)} < 18m\Omega @ V_{GS} = 4.5V \\ & \text{ESD Rating: } 2000V \text{ HBM} \end{split}$$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

### Application

- ●PWM application
- Load switch



#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2010E	NCE2010E	TSSOP-8	Ø330mm	12mm	3000 units

#### Absolute Maximum Ratings (T<sub>A</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	20	V	
Gate-Source Voltage	Vgs	±12	V	
Drain Current-Continuous	I <sub>D</sub>	7	А	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	30	A	
Maximum Power Dissipation	PD	1.5	W	
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C	

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	R <sub>0JA</sub>	83.3	°C/W
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#### Electrical Characteristics (T<sub>A</sub>=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	20	22.5		V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =20V, $V_{GS}$ =0V	-	-	1	μA



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Parameter	Symbol	Condition	Min	Тур	Max	Unit
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±10	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	0.5	0.7	0.9	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =6.5A	-	13	18	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =2.5V, I <sub>D</sub> =5.5A	-	17	24	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =7A	-	20	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>		-	1150	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V, F=1.0MHz	-	185	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	145	-	PF
Switching Characteristics (Note 4)				•		
Turn-on Delay Time	t <sub>d(on)</sub>		-	6		nS
Turn-on Rise Time	tr	$V_{DD}$ =10V,R <sub>L</sub> =1.35 $\Omega$	-	13		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =5V, $R_{GEN}$ =3 $\Omega$	-	52		nS
Turn-Off Fall Time	t <sub>f</sub>		-	16		nS
Total Gate Charge	Qg	)/ _10)/1 _74	-	15		nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =10V,I <sub>D</sub> =7A, V <sub>GS</sub> =4.5V	-	0.8	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	v <sub>GS</sub> =4.5v	-	3.2	-	nC
Drain-Source Diode Characteristics			•	•		•
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =1A	-	-	1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	7	А

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production



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EPOWE

http://www.ncepower.com

### **Typical Electrical and Thermal Characteristics**

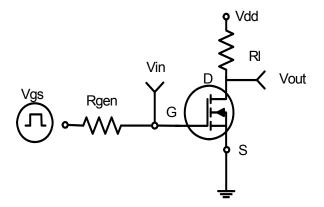
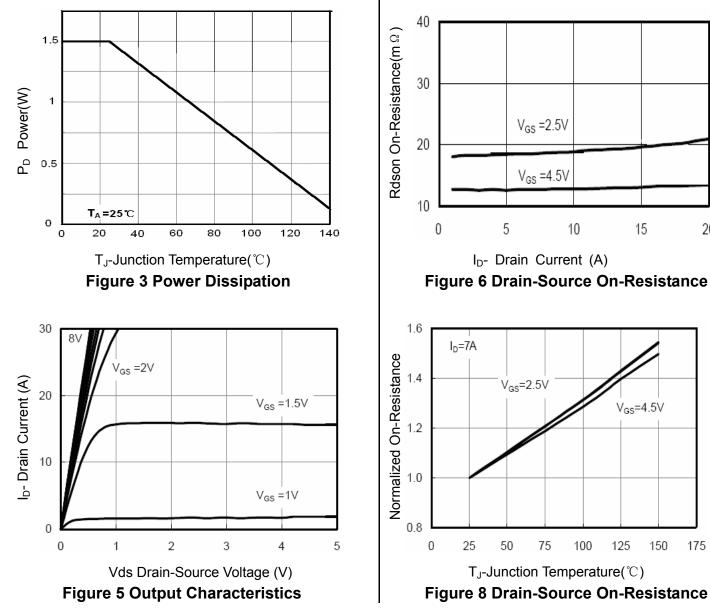


Figure 1:Switching Test Circuit



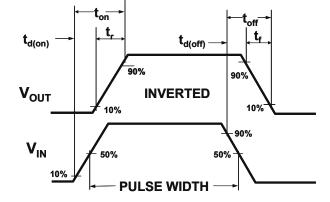
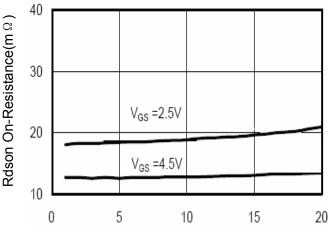


Figure 2:Switching Waveforms



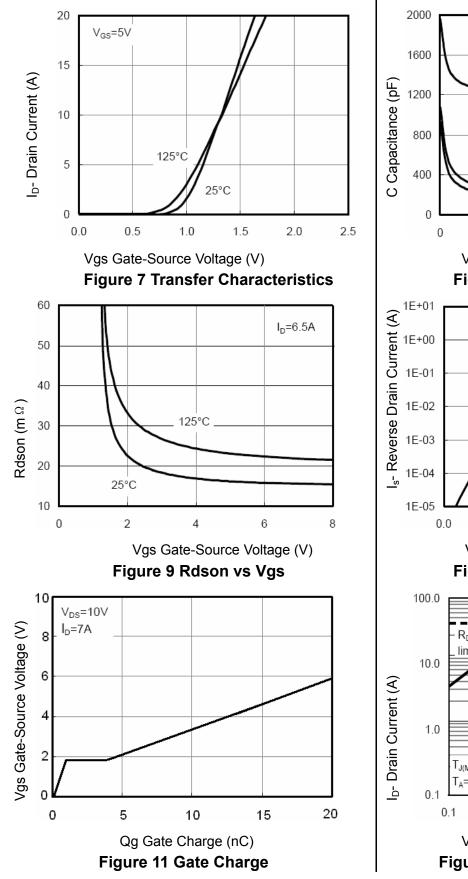
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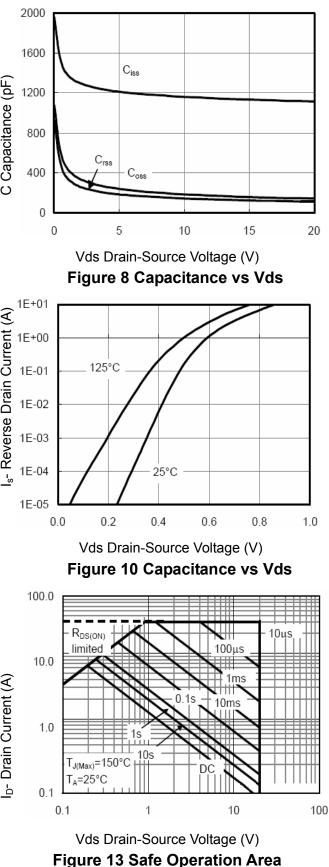
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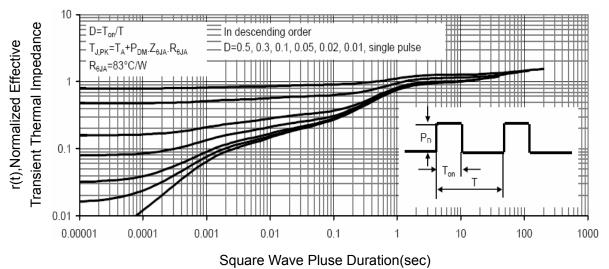


Figure 14 Normalized Maximum Transient Thermal Impedance

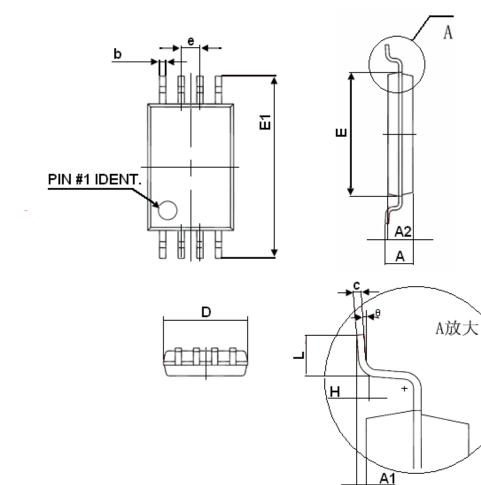
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# Tssop-8 Package Information



Symbol	Dimensions In Millimeters			
Symbol	Min	Max		
D	2.900	3.100		
E	4.300	4.500		
b	0.190	0.300		
С	0.090	0.200		
E1	6.250	6.550		
Α		1.100		
A2	0.800	1.000		
A1	0.020	0.150		
е	0.65(BSC)			
L	0.500	0.700		
Н	0.2	5(TYP)		
Θ	1° 7°			





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